

OneFive ORIGAMI XP

High-energy industrial femtosecond laser



HIGH POWER, SHORT PULSE DURATION

Ideal for ultra-high precision micromachining

The ORIGAMI XP is the first all-in-one, single-box, microjoule femtosecond laser on the market. The laser head, controller, and air-cooling system are all integrated in one small and robust package with a footprint so small it even fits into a hand luggage.

In the standard configuration the Origami XP has a center wavelength of 1030 nm. Additional outputs at 515 nm and 343 nm can be added by virtue of either the second or third harmonic generation module.

Applications

- Medical device fabrication
- Femtosecond micromachining
- Thin film patterning
- Sapphire drilling and cutting
- Glass cutting and drilling
- Ceramics drilling and scribing
- Polyimide drilling and cutting
- Multiphoton microscopy
- Ophthalmic applications
- FPD pixel repair

ONEFIVE ORIGAMI XP

Based on a monolithic chirped pulse amplification platform

The ORIGAMI system is based on a compact monolithic chirped pulse amplification platform capable of delivering up to 70 μJ pulse energy at 1030 nm, a 5 W average power, and a pulse duration below 400 fs.

Ultra-short pulses and excellent beam quality

Benefit from clean, ultra-short pulse duration, superior beam quality and unprecedented beam pointing stability due to the monolithic system design. It sets new standards for all-in-one femtosecond lasers in medical device manufacturing and ultra-high precision micromachining applications.

Get the dual wavelength SHG module

Depending on the model, the field-attachable second-harmonic module (SHG) makes it possible to switch between 20 μJ at 515 nm and 40 μJ at 1030 nm with the ORIGAMI XP, or between 35 μJ at 515 nm and 70 μJ at 1030 nm with the ORIGAMI XP-S. The wavelength is selected via software.

Or perhaps the dual wavelength THG module

Depending on the model, the attachable third-harmonic generation (THG) module makes it possible to switch between 10 μJ at 343 nm and 40 μJ at 1030 nm with the ORIGAMI XP, or between 17.5 μJ at 343 nm and 70 μJ at 1030 nm with the ORIGAMI XP-S. The wavelength is selected via software.

Cost-effective and OEM-ready

The ORIGAMI XP has been designed for easy and cost-effective integration. It comes with removable handles and offers full remote control capabilities.

A simple through-hole mounting system and high precision mechanical referencing planes ensure straightforward drop-in installation.

Model	10XP	10XP-S
Center wavelength	1030 nm	1030 nm
Pulse duration	< 400 fs	< 400 fs
Average power	> 4 W	> 5 W
Pulse energy	40 μJ	70 μJ
Peak power	> 80 MW	> 150 MW
Spectral bandwidth	< 5 nm	< 5 nm

Model	Dual wavelength SHG	
	05XP	05XP-S
Center wavelength	515 nm	515 nm
Pulse duration	< 400 fs	< 400 fs
Average power	> 2 W	> 2.5 W
Pulse energy	20 μJ	35 μJ
Peak power	> 40 MW	> 75 MW
Spectral bandwidth	< 2.5 nm	< 2.5 nm

Model	Dual wavelength THG	
	03XP	03XP-S
Center wavelength	343 nm	343 nm
Pulse duration	< 350 fs	< 350 fs
Average power	> 1 W	> 1 W
Pulse energy	10 μJ	17.5 μJ
Peak power	> 20 MW	> 40 MW
Spectral bandwidth	< 1 nm	< 1 nm

SPECIFICATIONS - SINGLE OUTPUT

Optical

Model	10XP	10XP-S
Center wavelength [nm]	1030	1030
Pulse duration [fs]	< 400	< 400
Average power [W]	> 4	> 5
Pulse energy [μ J]	40	70
Peak power [MW]	> 80	> 150
Spectral bandwidth [nm]	< 5	< 5
Pulse selection options	Single-shot to 1 MHz, Pulse-on-demand	Single-shot to 1 MHz, Pulse-on-demand
Beam quality (TEM_{00})	$M^2 \leq 1.2$	$M^2 \leq 1.2$
Polarization / PER (vertical) [dB]	> 22	> 22
Power stability (RMS, 12h, constant temp) [%]	< 1	< 1
Ellipticity	< 1.1	< 1.1
Pulse-to-pulse stability (RMS) [%]	< 1	< 1
Pointing stability	< 30 μ rad rms (12h), constant temperature < 15 μ rad / $^{\circ}$ C 18 – 28 $^{\circ}$ C	< 30 μ rad rms (12h), constant temperature < 15 μ rad / $^{\circ}$ C 18 – 28 $^{\circ}$ C

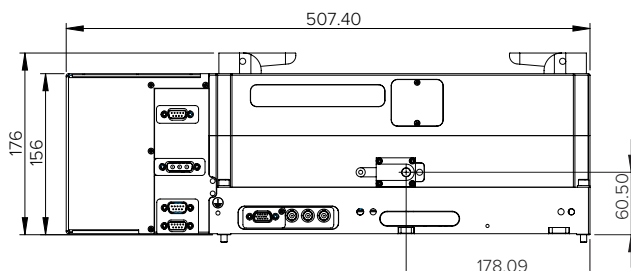
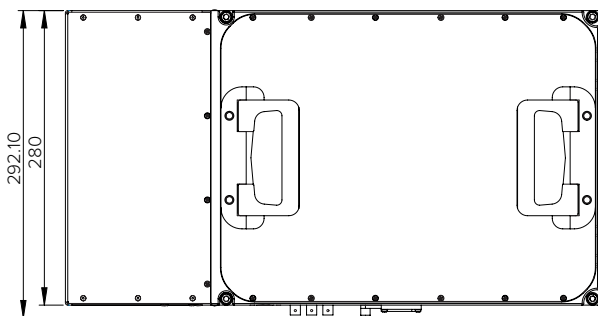
Features

- Air-cooled, single-box for ease of integration
- Single-shot and Pulse-on-Demand
- Outstanding energy and pointing stability
- Water cooling available
- Standard pulse width below 400 fs
- Average power up to 5 W at 1030 nm
- Pulse energy up to 70 μ J at 1030 nm

SPECIFICATIONS - SINGLE OUTPUT

Mechanical/Electrical

Laser output	Collimated free-space
Warm-up time [min.]	< 10 (warm start)
	< 30 (cold start)
Operation temperature [°C]	18 – 28
Storage temperature [°C]	-20 – 55
Power supply requirements	24 VDC/20A or 90-264 VAC, 47-63 Hz
Power consumption [W]	< 500
Laser head dimensions (WxHxD) [mm]	507.4 x 176 x 292.1
Power supply dimensions (WxHxD) [mm]	165 x 85 x 314
Laser head weight [kg]	28 kg (water-cooled)
	28 kg (air-cooled)
Cooling	Water or air



SPECIFICATIONS - DUAL WAVELENGTH SHG

Optical

Model	05XP	05XP-S
Center wavelength [nm]	515	515
Pulse duration [fs]	< 400	< 400
Average power [W]	> 2	> 2.5
Pulse energy [μ J]	20	35
Peak power [MW]	> 40	> 75
Spectral bandwidth [nm]	< 2.5	< 2.5
Pulse selection options	Single-shot to 1 MHz, Pulse-on-demand	Single-shot to 1 MHz, Pulse-on-demand
Beam quality (TEM_{00})	$M^2 \leq 1.3$	$M^2 \leq 1.3$
Polarization / PER (horizontal) [dB]	> 22	> 22
Power stability (RMS, 12h, constant temp) [%]	< 1	< 1
Ellipticity	< 1.2	< 1.2
Pulse-to-pulse stability (RMS) [%]	< 1	< 1
Pointing stability	< 30 μ rad rms (12h), constant temperature < 15 μ rad / $^{\circ}$ C 18 – 28 $^{\circ}$ C	< 30 μ rad rms (12h), constant temperature < 15 μ rad / $^{\circ}$ C 18 – 28 $^{\circ}$ C

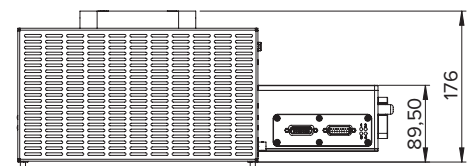
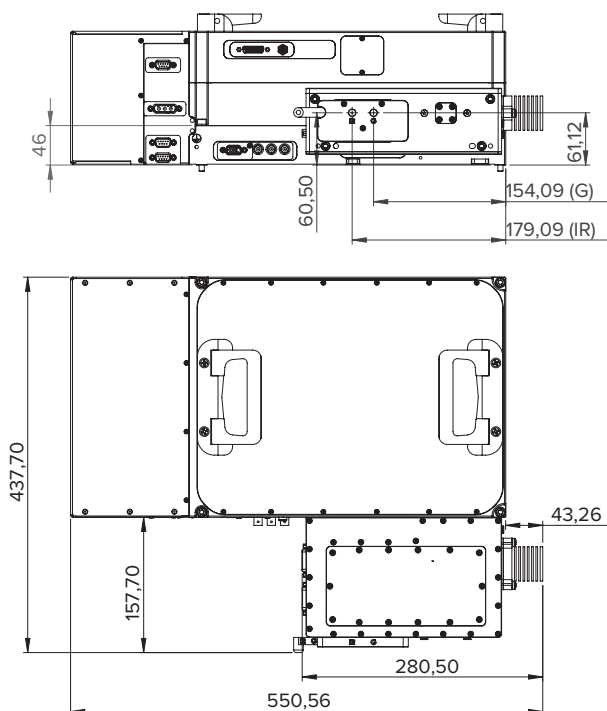
Features

- Air-cooled, single-box for ease of integration
- Single-shot and Pulse-on-Demand
- Dual wavelength SHG module
- Outstanding energy and pointing stability
- Water cooling available
- Standard pulse width below 400 fs
- Average power up to 5 W/2.5 W at 1030 nm/515 nm
- Pulse energy up to 70 μ J/35 μ J at 1030 nm/515 nm

SPECIFICATIONS - DUAL WAVELENGTH SHG

Mechanical/Electrical

Laser output	Collimated free-space
Warm-up time [min.]	< 10 (warm start)
	< 30 (cold start)
Operation temperature [°C]	18 – 28
Storage temperature [°C]	-20 – 55
Power supply requirements	24 VDC/20A or 90-264 VAC, 47-63 Hz
Power consumption [W]	< 500
Laser head dimensions (WxHxD) [mm]	550.6 x 176 x 437.7
Power supply dimensions (WxHxD) [mm]	165 x 85 x 314
Laser head weight [kg]	32 kg (water-cooled)
	32 kg (air-cooled)
Cooling	Water or air



SPECIFICATIONS - DUAL WAVELENGTH THG

Optical

Model	03XP	03XP-S
Center wavelength [nm]	343	343
Pulse duration [fs]	< 350	< 350
Average power [W]	> 1	> 1
Pulse energy [μ J]	10	17.5
Peak power [MW]	> 20	> 40
Spectral bandwidth [nm]	< 1	< 1
Pulse selection options	Single-shot to 1MHz. Pulse-on-demand	Single-shot to 1 MHz, Pulse-on-demand
Beam quality (TEM_{00})	$M^2 \leq 1.3$	$M^2 \leq 1.3$
Polarization / PER (vertical) [dB]	> 20	> 20
Beam diameter [mm]	2	2
Power stability (RMS, 12h, constant temp) [%]	< 2	< 2
Ellipticity	< 1.2	< 1.2
Pulse-to-pulse stability (RMS) [%]	< 2	< 2
Pointing stability	< 30 μ rad rms (12h), constant temp. < 15 μ rad / °C 18 – 28 °C	< 30 μ rad rms (12h), constant temperature < 15 μ rad / °C 18 – 28 °C

Features

- Air-cooled, single-box for ease of integration
- Single-shot and Pulse-on-Demand
- Dual wavelength THG module
- Outstanding energy and pointing stability
- Water cooling available
- Standard pulse width below 350 fs
- Average power up to 5 W/1 W at 1030 nm/343 nm
- Pulse energy up to 70 μ J/17.5 μ J at 1030 nm/343 nm

SPECIFICATIONS - DUAL WAVELENGTH THG

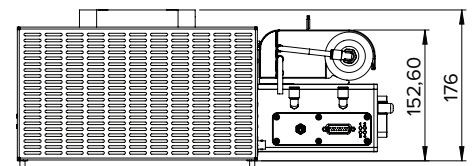
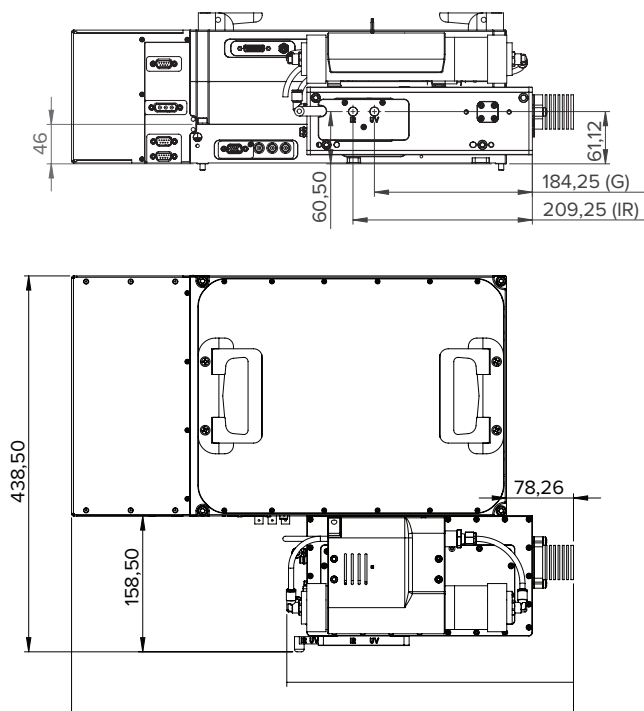
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Laser head weight [kg]	33 kg (water-cooled)
	33 kg (air-cooled)
Cooling	Water or air

Support and warranty

All ORIGAMI products come with an industry-leading reliability.

The product is covered by a comprehensive warranty. Service options are available. For details, please enquire.



All ORIGAMI products are produced under our quality management system certified in accordance with the ISO 9001:2015 and ISO 13485:2016 standard.

